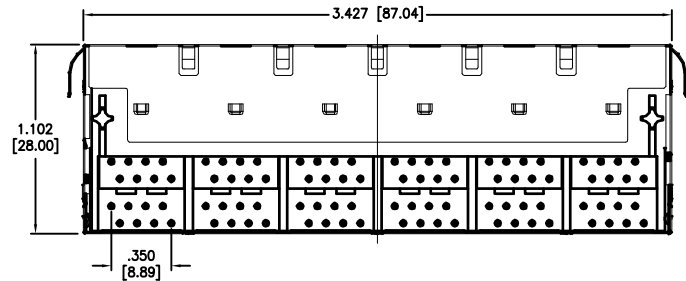
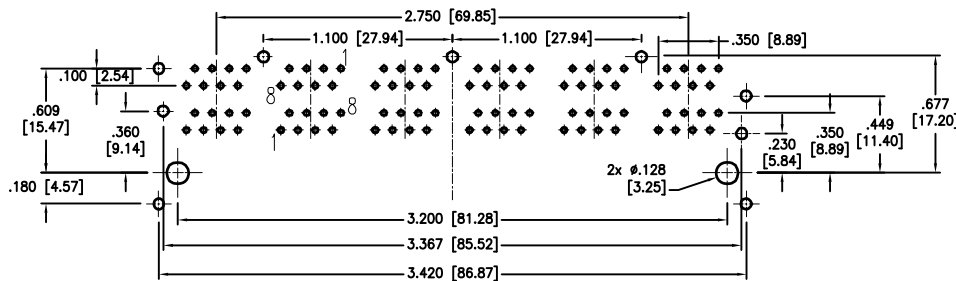
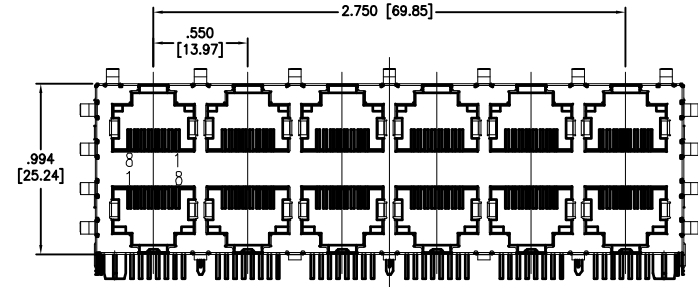
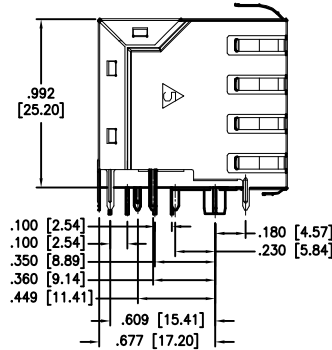


APPROVED: _____
 DATE: _____ TITLE: _____

Rev	AWO #	Description	Date	Appr
-		RELEASED	11/25/08	
A		REVISED SHAPE	11/17/11	
B		UPDATE DRAWING	11/18/20	LH/RL



SPECIFICATIONS: Recommended PCB Layout

Material:
 Insulator: PA66, rated UL 94V-0
 Insulator color: Black
 Contacts: Copper Alloy
 Shield: Copper Alloy, Nickel plated
 Plating:
 Round contact
 Gold over Nickel underplate overall
 Flat contact
 Gold over Nickel underplate on contact area
 Tin over Nickel underplate on solder tails

Electrical:
 Voltage rating: 150 VAC RMS
 Current rating: 1.5 Amp
 Contact Resistance: 20 mohms max.
 Insulation resistance: 1,000 Mohms min @500VDC
 Dielectric withstanding voltage:
 Contact to Contact: 1,000 VDC or AC Peak for 1 minute
 Contact to Shield: 1,500 VDC or AC Peak for 1 minute
 Temperature Rating:
 Operating temperature: -40°C to +85°C

Environmental:
 Lead free, RoHS compliant.



UNLESS OTHERWISE SPECIFIED
 ALL DIMENSIONS ARE INCHES [MM]
 TOLERANCES: EXCEPT AS NOTED
 INCHES HOLES
 .X ±.10 Ø.X ±.10
 .XX ±.020 Ø.XX ±.015
 .XXX ±.015 Ø.XXX ±.010

APPROVALS		DATE
DRAWN	DY	11/25/08
CHECKED		
APPROVED		



TITLE: MODULAR JACK GANGED, 12 PORT, 8P8C
 W/ PANEL GROUND

SIZE	PART NO.	REV.
X	MTJG-12-88JX1-FSG-PG	B
REF: S00005C	SCALE: NTS	SHEET 1 OF 1